



ZZ3
This Assembly Note will show in the PcbDoc and associated outputs

ZZ1
This Assembly Note will show in the PcbDoc and associated outputs

ZZ2

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00643	REV: E2	SUN REV: Not In VersionControl
	TID #: 00643		
PLOT NAME = Top Assembly Drawing	GENERATED : 9/9/2015	11:22:12 AM	TEXAS INSTRUMENTS

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